Variant: 0

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TIDA-00851 REV E1 Bill of Materials



| Item # | Designator | Quantity | Value | PartNumber | Manufacturer | Description | PackageReference |
|--------|-----------------------|----------|---------|-----------------------|---------------------------------|--|------------------------------|
| 1 | !PCB | 1 | | TIDA-00851 | Any | Printed Circuit Board | |
| | C1, C2, C3, C6, C7 | 5 | 0.1uF | C1005X7R1H104K050BB | TDK | CAP, CERM, 0.1 μF, 50 V, +/- 10%, X7R, 0402 | 0402 |
| | C4 | 1 | 1000pF | GRM155R61C102KA01D | MuRata | CAP, CERM, 1000 pF, 16 V, +/- 10%, X5R, 0402 | 0402 |
| | C5 | 1 | 0.01uF | 500X14W103MV4T | Johanson Technology | CAP, CERM, 0.01 µF, 50 V, +/- 20%, X7R, 0603 | 0603 |
| | C8 | 1 | 0.01uF | C1608X7R2A103K | TDK | CAP, CERM, 0.01 µF, 100 V, +/- 10%, X7R, 0603 | 0603 |
| | D3, D5 | 2 | 100V | BAT46WJ.115 | NXP Semiconductor | Diode, Schottky, 100 V, 0.25 A, SOD-323F | SOD-323F |
| | D4, D7 | 2 | 90V | CDSU101A | Comchip Technology | Diode, Switching, 90 V, 0.1 A, SOD-523F | SOD-523F |
| | D6 | 1 | 39V | SM6T39CA | STMicroelectronics | Diode, TVS, Bi, 39 V, 600 W, SMB | SMB |
| 9 | J1 | 1 | | 61300411121 | Wurth Elektronik | Header, 2.54 mm, 4x1, Gold, TH | Header, 2.54mm, 4x1, TH |
| 10 | J2 | 1 | | 61300211121 | Wurth Elektronik | Header, 2.54 mm, 2x1, Gold, TH | Header, 2.54mm, 2x1, TH |
| 11 | J3 | 1 | | GRPB021VWVN-RC | Sullins Connector Solutions | Header, 50mil, 2x1, Gold, TH | 2x1 Header |
| 12 | J4, J5 | 2 | | BB02-BS101-KA8-025B00 | GradConn | Header, 1.27mm, 5x2, SMT | Header, 1.27mm, 5x2, SMT |
| 13 | L3, L4 | 2 | 600 ohm | MI1206K601R-10 | Laird-Signal Integrity Products | Ferrite Bead, 600 ohm @ 100 MHz, 1.5 A, 1206 | 1206 |
| 14 | Q1 | 1 | 80 V | BCP56-16 | STMicroelectronics | Transistor, NPN, 80 V, 1 A, SOT-223 | SOT-223 |
| 15 | Q4 | 1 | 100V | BSS169H6327XTSA1 | Infineon Technologies | MOSFET, N-CH, 100 V, 0.17 A, SOT-23 | SOT-23 |
| 16 | R1 | 1 | 150 | CRCW0402150RFKED | Vishay-Dale | RES, 150, 1%, 0.063 W, 0402 | 0402 |
| 17 | R2, R3 | 2 | 75k | CRCW040275K0JNED | Vishay-Dale | RES, 75 k, 5%, 0.063 W, 0402 | 0402 |
| 18 | R4 | 1 | 4.99k | RG1608P-4991-B-T5 | Susumu Co Ltd | RES, 4.99 k, 0.1%, 0.1 W, 0603 | 0603 |
| 19 | R5 | 1 | 10.0k | CRCW040210K0FKED | Vishay-Dale | RES, 10.0 k, 1%, 0.063 W, 0402 | 0402 |
| 20 | TP1 | 1 | Red | 5000 | Keystone | Test Point, Miniature, Red, TH | Red Miniature Testpoint |
| 21 | TP2 | 1 | Black | 5001 | Keystone | Test Point, Miniature, Black, TH | Black Miniature Testpoint |
| 22 | U1 | 1 | | PGA900ARHHR | Texas Instruments | PRESSURE SENSOR SIGNAL CONDITIONER, RHH0036C | RHH0036C |
| 23 | FID1, FID2, FID3 | 0 | | N/A | N/A | Fiducial mark. There is nothing to buy or mount. | Fiducial |
| 24 | R6, R12 | 0 | 0 | CRCW06030000Z0EA | Vishay-Dale | RES, 0, 5%, 0.1 W, 0603 | 0603 |

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